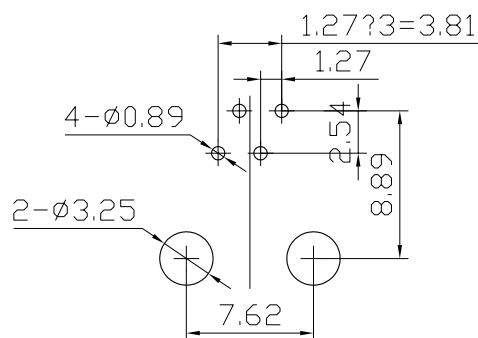
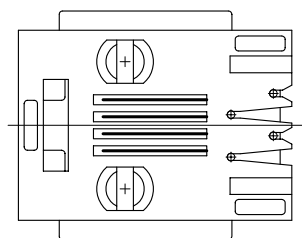
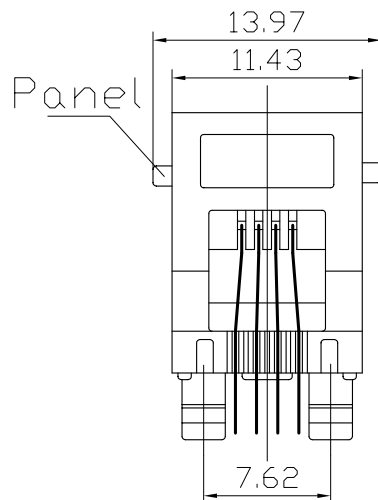
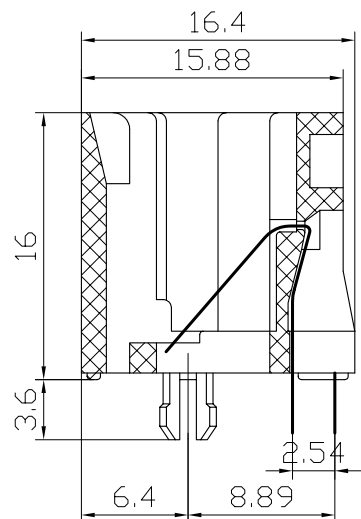




PC Board Layout
Component Side Shown

1. HOUSING MATERIAL :PBT
2. CONTACT MATERIAL :PHOSPHOR BRONZE t=0.35mm.
3. PLATING : GOLD PLATING 1u" OVER NICKEL

1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE
:1000V AC RMS 50Hz. 1MIN.

1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.

 深圳市华宇创精密电子有限公司					
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: RJ11 180 ° DIP 4P4C	
		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW08-RJ11-164E	
 UNIT: mm [inch]		APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HYC-RJ16041915	
			SHEET NO. 1 OF 1		